COMPLIANT

HALOGEN FREE Available



Dual N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
	V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
Channel-1		0.019 at $V_{GS} = 10 \text{ V}$	8.0			
	30	0.026 at V _{GS} = 4.5 V	6.9			
Channel-2	30	0.035 at V _{GS} = 10 V	6.0			
		0.048 at V _{GS} = 4.5 V	5.0			

SO-8 D_1 D_2 D_2 Top View

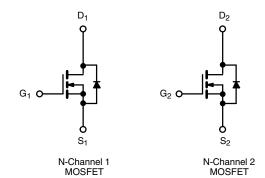
Ordering Information: Si4974DY-T1-E3 (Lead (Pb)-free) Si4974DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFETs
- 100 % R_g Tested

APPLICATIONS

- · Logic DC/DC
 - Notebook PC



ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted									
Parameter			Channel-1		Channel-2		11		
		Symbol	10 s	Steady State	10 s	Steady State	Unit		
Drain-Source Voltage	V_{DS}	30							
Gate-Source Voltage		V_{GS}	± 20						
Ocalian - Ducin Ocaman (T. 150.00)3	T _A = 25 °C	- I _D	8.0	6.0	6.0	4.4			
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		6.5	4.7	4.8	3.5			
Pulsed Drain Current		I _{DM}		40 30			Α		
Continuous Source Current (Diode Conduction) ^a		I _S	1.8	1.0	1.8	1.0			
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}		15 7		7			
Avalanche Energy		E _{AS}		11	1		2.45		mJ
	T _A = 25 °C	Б	2	1.1	2	1.1	W		
Maximum Power Dissipation ^a	T _A = 70 °C	P _D	1.3	0.7	1.3	0.7			
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150				°C			

THERMAL RESISTANCE RATINGS								
		Chan	inel-1	Channel-2		I I m la		
Parameter		Symbol	Тур.	Max.	Тур.	Max.	Unit	
Maximum Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	50	62.5	52	62.5		
	Steady State	¹ ¹thJA	90	110	91	110	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	30	40	32	40		

a. Surface Mounted on 1" x 1" FR4 board.

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MOSFET SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted								
Parameter	Symbol	Test Conditions				Max.	Unit	
Static	1				1			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	Ch-1	1.0		3.0	٧	
Gate Theoritic Voltage			Ch-2	1.0		3.0	· ·	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	Ch-1			± 100	nA	
	400		Ch-2			± 100	L	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	Ch-1			1	_	
			Ch-2			1	μΑ	
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$	Ch-1			15	1 '	
			Ch-2 Ch-1	20		15		
On-State Drain Current ^b	$I_{D(on)}$	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	Ch-2	20			Α	
Drain-Source On-State Resistance ^b		V _{GS} = 10 V, I _D = 8.0 A	Ch-1	20	0.016	0.019	+	
		$V_{GS} = 10 \text{ V}, I_D = 6.0 \text{ A}$	Ch-2		0.010	0.019		
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 6.9 \text{ A}$	Ch-1		0.029	0.035	Ω	
		$V_{GS} = 4.5 \text{ V}, I_D = 5.0 \text{ A}$	Ch-2		0.0213		-	
Forward Transconductance ^b		-	_			0.048	<u> </u>	
	g _{fs}	V _{DS} = 15 V, I _D = 8.0 A	Ch-1		19		s	
	0	$V_{DS} = 15 \text{ V}, I_{D} = 6.0 \text{ A}$	Ch-2		13			
Diode Forward Voltage ^b	V _{SD}	$I_S = 1.8 \text{ A}, V_{GS} = 0 \text{ V}$	Ch-1		0.8	1.1	V	
		$I_S = 1.8 \text{ A}, V_{GS} = 0 \text{ V}$	Ch-2		8.0	1.1		
Dynamic ^a								
Total Gate Charge	Qg	Channel-1 V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 8.0 A	Ch-1		7.0	11	nC	
			Ch-2		3.3	5		
Gate-Source Charge	Q _{gs}	105 10 1, 165 110 1, 16 010 11	Ch-1		2.6			
		Channel-2	Ch-2		1.2			
Gate-Drain Charge		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 6.0 \text{ A}$	Ch-1		3.0			
			Ch-2	0.0	1.5	0.0		
Gate Resistance	R_g		Ch-1 Ch-2	0.8	1.5 1.95	2.3	Ω	
			Ch-1	0.9	8	15		
Turn-On Delay Time	t _{d(on)}	Channel-1	Ch-2		6	10		
		V_{DD} = 15 V, R_L = 15 Ω $I_D \cong$ 1 A, V_{GEN} = 10 V, R_G = 6 Ω	Ch-1		12	20		
Rise Time			Ch-2		11	18		
Turn-Off Delay Time	t _{d(off)}	Charrel	Ch-1		22	35		
		Channel-2 $V_{DD} = 15 \text{ V, R}_{L} = 15 \Omega$	Ch-2		15	25	ns	
Fall Time	t _f	$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 6 \Omega$	Ch-1		6	10		
		J July -	Ch-2		6	10		
Source Drain Powerce Becourse Time	+	t _{rr} I _F = 1.8 A, dl/dt = 100 A/μs	Ch-1		20	40		
Source-Drain Reverse Recovery Time	^L rr		Ch-2		15	30		

Notes:

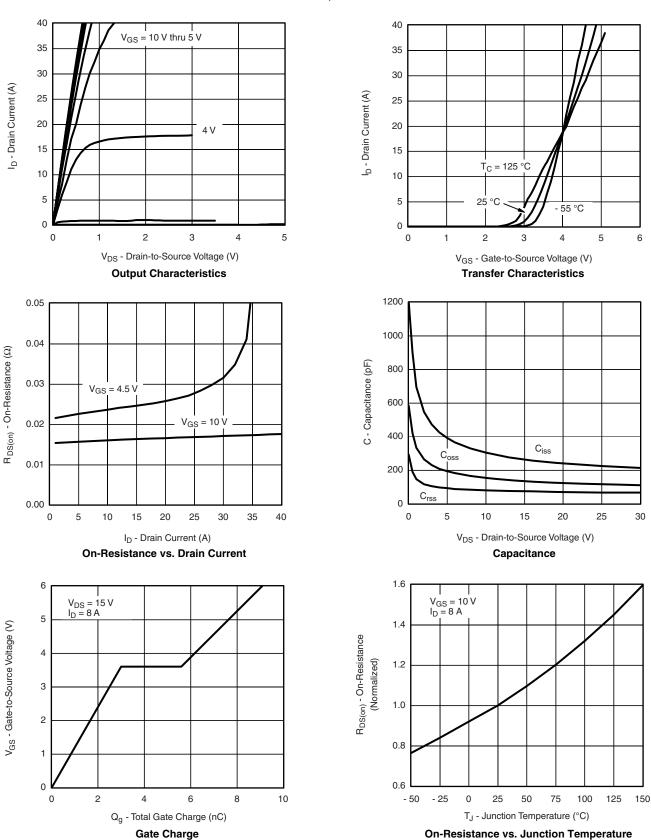
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



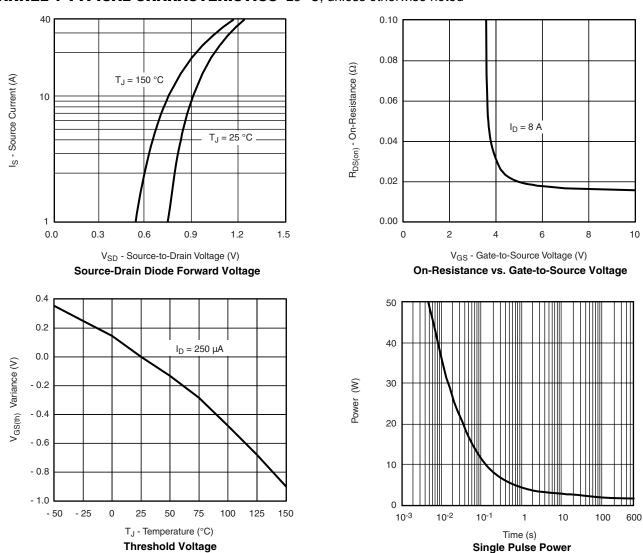


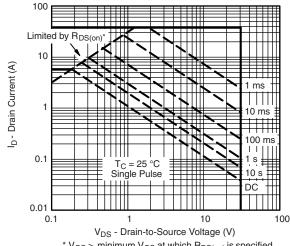
CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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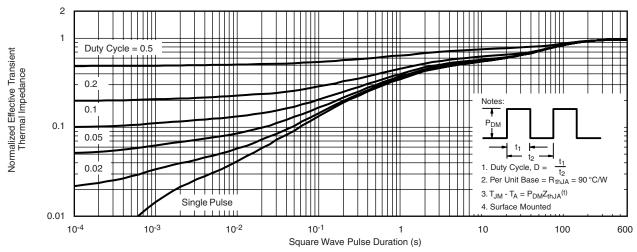


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

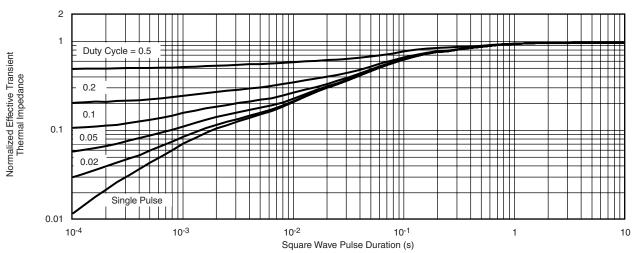
Safe Operating Area, Junction-to-Case



CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



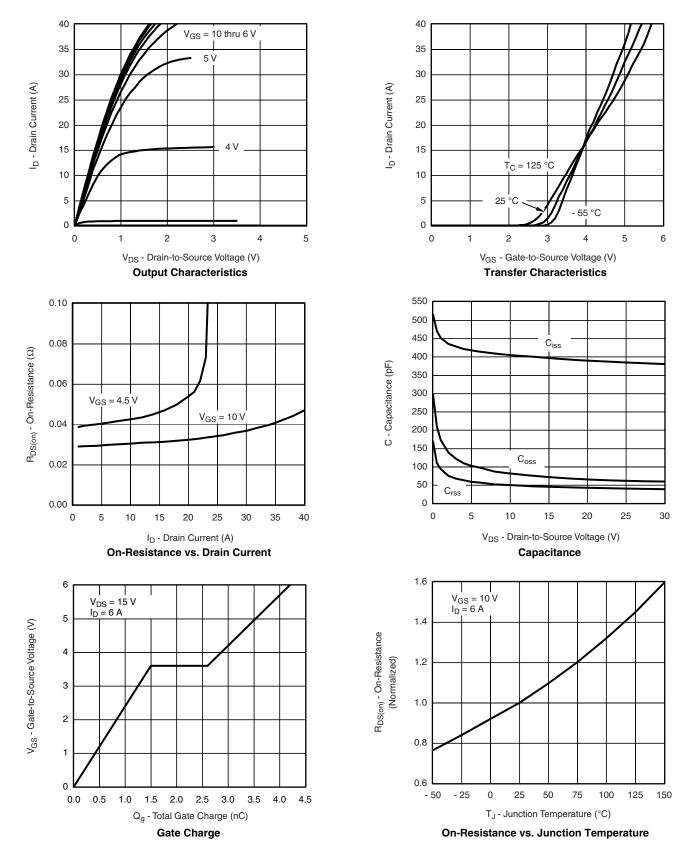
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



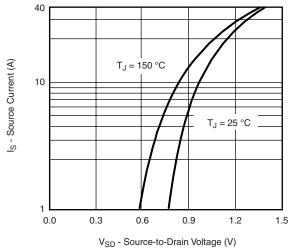
CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



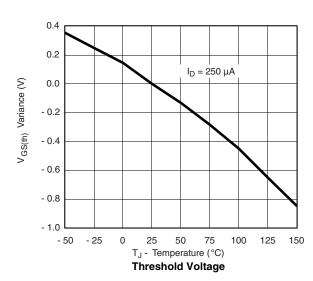


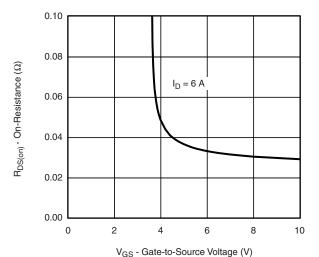


CHANNEL-2 TYPICAL CHARACTERISTICS 25 $^{\circ}$ C, unless otherwise noted

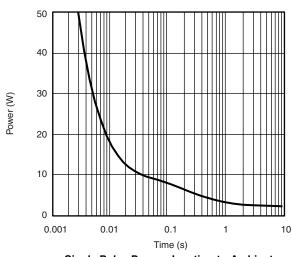


Source-Drain Diode Forward Voltage

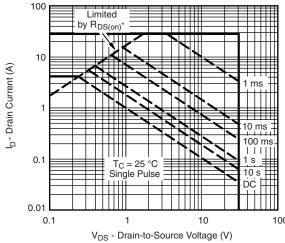




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

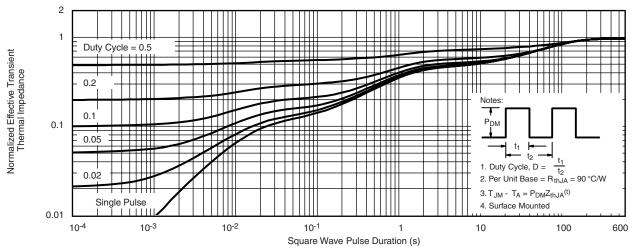


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

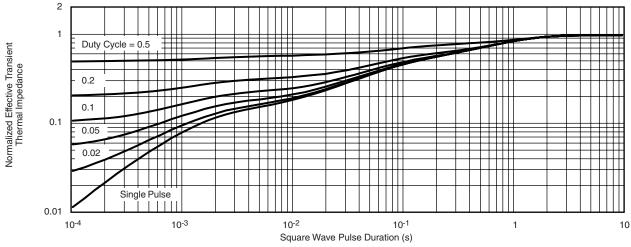
Safe Operating Area, Junction-to-Case



CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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